

SAW Resonators/Filter

SFD-712

Features

◆RoHS Compliant

◆Through hole type



Absolute Maximum Ratings (Ta=25°C)

Item	Value
DC Voltage V _{DC}	3V
Instantaneous DC Voltage	10V(Less then 1/60 sec)
AC Voltage V _{PP}	10Vp-p (50Hz/60Hz)
Operation Temperature	-40°C to +85°C
Storage Temperature	-45°C to +90°C
Oscillation Power Level	0.2 mW

Electronic Characteristics

Item	Specifications
Nominal Frequency Range	55.250MHz to 222.150MHz
Tolerance	±75KHz

Dimensions

Pin No.	Function
Pin 1	Input
Pin 2	Ground
Pin 3	Output
Pin 4	NC

Unit:mm

Equivalent LC Model

<p>Test Circuit</p>	
<p>Note: Reference temperature shall be 25 ± 2°C. However, the measurement may be carried out at 5°C to 35°C unless there is a dispute</p>	

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Reliability

Mechanical Shock	The components shall remain within the electrical specifications after 1000 shocks, acceleration 392 m/s^2 , duration 6 milliseconds.
Vibration Fatigue	The components shall remain within the electrical specifications after loaded vibration at 20 Hz, amplitude 1.5mm, for 2 hours.
Terminal Strength	The components shall remain within the electrical specifications after pulled 2 kgs weight for 10 seconds towards an axis of each terminal.
High Temperature Storage	The components shall remain within the electrical specifications after being kept at the $85^\circ\text{C} \pm 2^\circ\text{C}$ for 48 hours, then kept at room temperature for 2 hours.
Low Temperature Storage	The components shall remain within the electrical specifications after being kept at the $-40^\circ\text{C} \pm 2^\circ\text{C}$ for 48 hours, then kept at room temperature for 2 hours.
Temperature Cycle	The components shall remain within the electrical specifications after 5 cycles of high and low temperature testing (one cycle: 80°C for 30 minutes $\rightarrow 25^\circ\text{C}$ for 5 minutes $\rightarrow -25^\circ\text{C}$ for 30 minutes) then kept at room temperature for 2 hours.
Solder-heat Resistance	The components shall remain within the electrical specifications after dipped in the solder at 260°C for 10 ± 1 seconds, then kept at room temperature for 2 hours. (Terminal must be dipped leaving 1.5 mm from the case).
Solderability	Solderability of terminal shall be kept at more than 80% after dipped in the solder flux at $230^\circ\text{C} \pm 5^\circ\text{C}$ for 5 ± 1 seconds.

Remarks

Static voltage	Static voltage between signal load & ground may cause deterioration & destruction of the component. Please avoid static voltage.
Ultrasonic cleaning	Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning.
Soldering	Only leads of component may be soldered. Please avoid soldering another part of component.

